

Component	Range	Parameter Description
BJT	-	hFE(DC Current Gain), Ube(Base-Emitter Voltage), Ic(Collector Current), Icbo(Collector Cut-off Current ($IB=0$)), Ices(Collector short Current), Uf(Forward Voltage of protecting diode)
Diode	Forward Voltage <4.50V	Forward Voltage, Diode Capacitance, Ir(Reverse Current)
Double Diodes		Forward Voltage
Zener Diode	0.01-4.50V (Transistor test area)	Forward Voltage, Reverse Voltage
	0.01-30V (Zener Diode test area)	Reverse Voltage
MOSFET	JFET	Cg(Gate Capacitance), Id(Drain Current) at Vgs(Gate to Source Threshold Voltag), Uf(Forward Voltage of protecting diode)
	IGBT	Id(Drain Current) at Vgs(Gate to Source Threshold Voltag), Uf(Forward Voltage of protecting diode)
	MOSFET	Vt(Gate to Source Threshold Voltag), Cg(Gate Capacitance), Rds(Drain to Source On Resistance), Uf(Forward Voltage of protecting diode)
Thyristor	Igt(Gate trigger current)<6mA	Gate trigger voltage
Triac	25pF-100mF	Capacitance, ESR(Equivalent Series Resistance), Vloss
Capacitor		
Resistor	0.01-50MΩ	Resistance
Inductor	0.01mH-20H	Inductance, DC Resistance
Battery	0.1-4.5V	Voltage, Battery Polarity